

N-Channel Power MOSFET (5A, 600Volts)

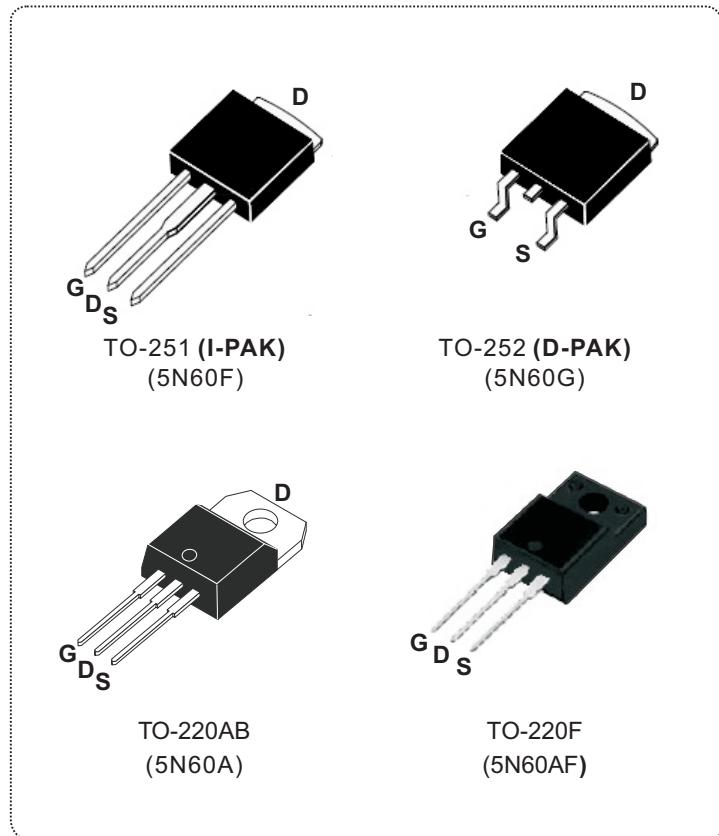
DESCRIPTION

The Nell **5N60** is a three-terminal silicon device with current conduction capability of 5A, fast switching speed, low on-state resistance, breakdown voltage rating of 600V, and max. threshold voltage of 4 volts.

They are designed for use in applications such as switched mode power supplies, DC to DC converters, **PWM** motor controls, bridge circuits and general purpose switching applications.

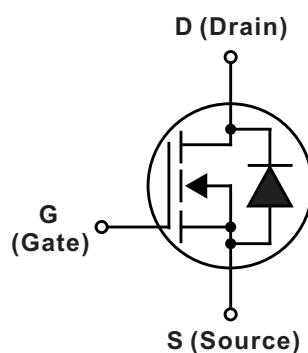
FEATURES

- $R_{DS(ON)} = 2.2\Omega @ V_{GS} = 10V$
- Ultra low gate charge(20nC max.)
- Low reverse transfer capacitance ($C_{RSS} = 6.5pF$ typical)
- Fast switching capability
- 100% avalanche energy specified
- Improved dv/dt capability
- 150°C operation temperature



PRODUCT SUMMARY

| | |
|---------------------------|----------------------|
| I_D (A) | 5 |
| V_{DSS} (V) | 600 |
| $R_{DS(ON)}$ (Ω) | 2.2 @ $V_{GS} = 10V$ |
| Q_G (nC) max. | 20 |



| ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$ unless otherwise specified) | | | | |
|---|---|--|----------------|--------------|
| SYMBOL | PARAMETER | TEST CONDITIONS | VALUE | UNIT |
| V_{DSS} | Drain to Source voltage | $T_J=25^\circ\text{C}$ to 150°C | 600 | V |
| V_{DGR} | Drain to Gate voltage | $R_{GS}=20\text{ k}\Omega$ | 600 | |
| V_{GS} | Gate to Source voltage | | ± 30 | |
| I_D | Continous Drain Current | $T_C=25^\circ\text{C}$ | 5 | A |
| | | $T_C=100^\circ\text{C}$ | 3.1 | |
| I_{DM} | Pulsed Drain current(Note 1) | | 20 | |
| I_{AR} | Avalanche current(Note 1) | | 5 | |
| E_{AR} | Repetitive avalanche energy(Note 1) | $I_{AR}=5\text{ A}$, $R_{GS}=50\Omega$, $V_{GS}=10\text{ V}$ | 10 | mJ |
| E_{AS} | Single pulse avalanche energy (Note 2) | $I_{AS}=5\text{ A}$, $L = 16.8\text{ mH}$ | 210 | |
| dv/dt | Peak diode recovery dv/dt (Note 3) | | 4.5 | V/ns |
| P_D | Total power dissipation | $T_C=25^\circ\text{C}$ | TO-251/ TO-252 | 54 |
| | | | TO-220AB | 100 |
| | | | TO-220F | 36 |
| T_J | Operation junction temperature | | -55 to 150 | °C |
| T_{STG} | Storage temperature | | -55 to 150 | |
| T_L | Maximum soldering temperature, for 10 seconds | 1.6mm from case | 300 | |
| | Mounting torque, #6-32 or M3 screw | | 10 (1.1) | lbf·in (N·m) |

Note: 1.Repetitive rating: pulse width limited by junction temperature.

2. $I_{AS} = 5\text{ A}$, $V_{DD} = 50\text{ V}$, $L = 16.8\text{ mH}$, $R_{GS} = 25\Omega$, starting $T_J=25^\circ\text{C}$.

3. $I_{SD} \leq 5\text{ A}$, $di/dt \leq 200\text{ A}/\mu\text{s}$, $V_{DD} \leq V_{(BR)DSS}$, starting $T_J=25^\circ\text{C}$.

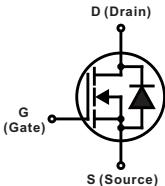
| THERMAL RESISTANCE | | | | | | |
|--------------------|---|----------------|------|------|------|------|
| SYMBOL | PARAMETER | | Min. | Typ. | Max. | UNIT |
| $R_{th(j-c)}$ | Thermal resistance, junction to case | TO-251/ TO-252 | | | 2.3 | °C/W |
| | | TO-220AB | | | 1.25 | |
| | | TO-220F | | | 3.5 | |
| $R_{th(j-a)}$ | Thermal resistance, junction to ambient | TO-251/TO-252 | | | 160 | °C/W |
| | | TO-220AB | | | 62.5 | |
| | | TO-220F | | | 62.5 | |

| ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$ unless otherwise specified) | | | | | | |
|---|--|---|-------------------------|------|------|------------------|
| SYMBOL | PARAMETER | TEST CONDITIONS | Min. | Typ. | Max. | UNIT |
| $V_{(\text{BR})\text{DSS}}$ | Drain to Source breakdown voltage | $I_D=250\mu\text{A}, V_{GS}=0\text{V}$ | 600 | | | V |
| $\Delta V_{(\text{BR})\text{DSS}/\Delta T_J}$ | Breakdown voltage temperature coefficient | $I_D=250\mu\text{A}, V_{DS}=V_{GS}$ | | 0.6 | | $^\circ\text{C}$ |
| I_{DSS} | Drain to source leakage current | $V_{DS}=600\text{V}, V_{GS}=0\text{V}$ | $T_C=25^\circ\text{C}$ | | 10 | μA |
| | | $V_{DS}=480\text{V}, V_{GS}=0\text{V}$ | $T_C=125^\circ\text{C}$ | | 100 | |
| I_{GSS} | Gate to source forward leakage current | $V_{GS}=30\text{V}, V_{DS}=0\text{V}$ | | | 100 | nA |
| | Gate to source reverse leakage current | $V_{GS}=-30\text{V}, V_{DS}=0\text{V}$ | | | -100 | |
| $R_{\text{DS(ON)}}$ | Static drain to source on-state resistance | $I_D=2.5\text{A}, V_{GS}=10\text{V}$ | | 1.8 | 2.2 | Ω |
| $V_{\text{GS(TH)}}$ | Gate threshold voltage | $V_{GS}=V_{DS}, I_D=250\mu\text{A}$ | 2 | | 4.0 | V |
| C_{ISS} | Input capacitance | $V_{DS}=25\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$ | | 515 | 670 | pF |
| C_{OSS} | Output capacitance | | | 55 | 72 | |
| C_{RSS} | Reverse transfer capacitance | | | 6.5 | 8.5 | |
| $t_{d(\text{ON})}$ | Turn-on delay time | $V_{DD}=300\text{V}, V_{GS}=10\text{V}, I_D=5\text{A}, R_{GS}=25\Omega$ (Note 1, 2) | | 10 | 30 | ns |
| t_r | Rise time | | | 42 | 90 | |
| $t_{d(\text{OFF})}$ | Turn-off delay time | | | 38 | 85 | |
| t_f | Fall time | | | 45 | 100 | |
| Q_G | Total gate charge | $V_{DD}=480\text{V}, V_{GS}=10\text{V}, I_D=5\text{A}$ (Note 1,2) | | 15 | 20 | nC |
| Q_{GS} | Gate to source charge | | | 2.5 | | |
| Q_{GD} | Gate to drain charge (Miller charge) | | | 6.5 | | |

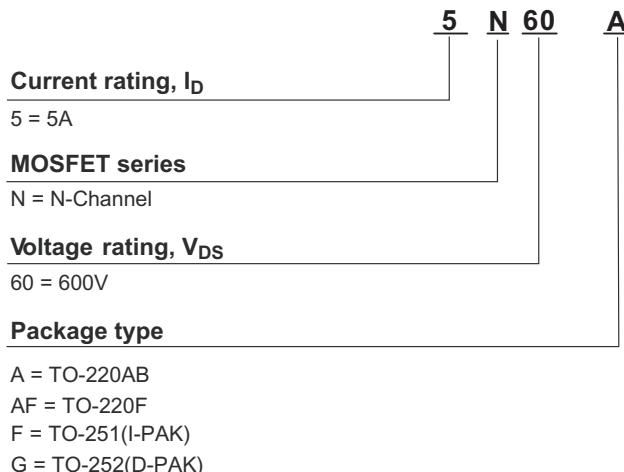
| SOURCE TO DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise specified) | | | | | | |
|--|------------------------------------|---|------|------|------|---------------|
| SYMBOL | PARAMETER | TEST CONDITIONS | Min. | Typ. | Max. | UNIT |
| V_{SD} | Diode forward voltage | $I_{SD}=5\text{A}, V_{GS}=0\text{V}$ | | | 1.4 | V |
| I_s (I_{SD}) | Continuous source to drain current | Integral reverse P-N junction diode in the MOSFET | | | 5 | A |
| I_{SM} | Pulsed source current | | | | 20 | |
| t_{rr} | Reverse recovery time | $I_{SD}=5\text{A}, V_{GS}=0\text{V}, dI_F/dt=100\text{A}/\mu\text{s}$ | | 300 | | ns |
| Q_{rr} | Reverse recovery charge | | | 2.2 | | μC |

Note: 1. Pulse test: Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.



ORDERING INFORMATION SCHEME



■ TEST CIRCUITS AND WAVEFORMS

Fig.1A Peak diode recovery dv/dt test circuit

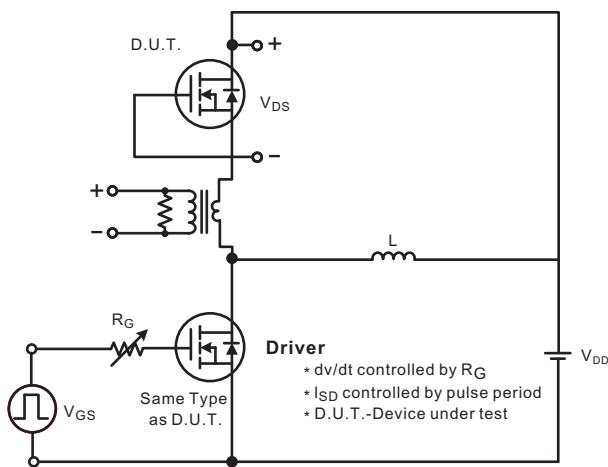
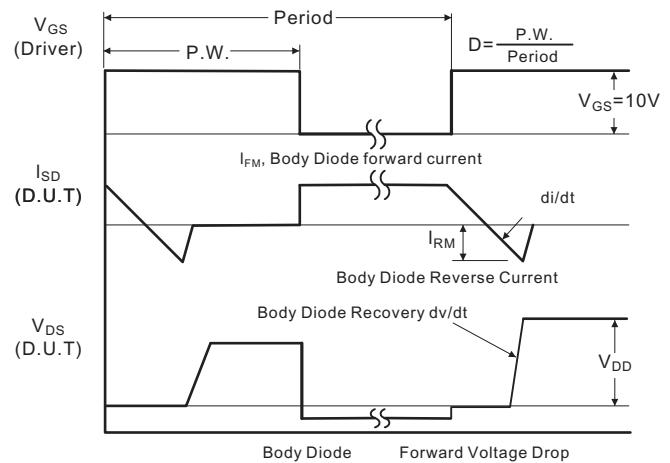
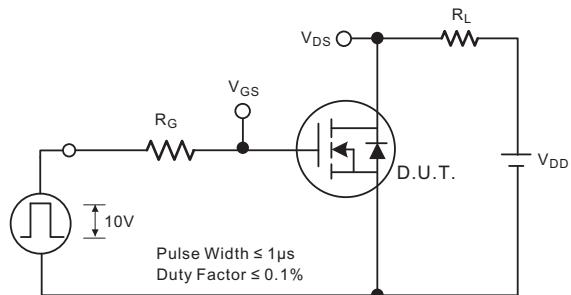
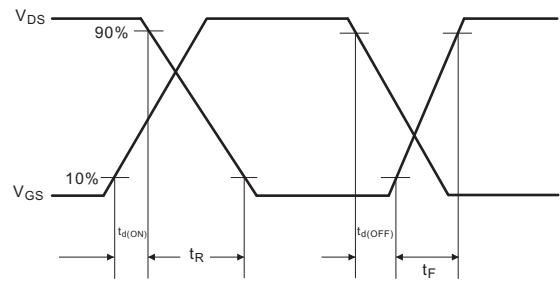
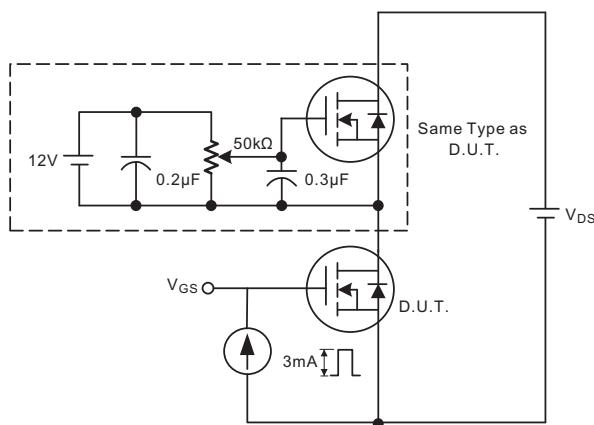
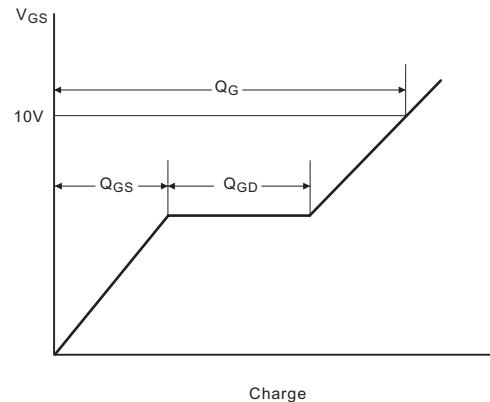
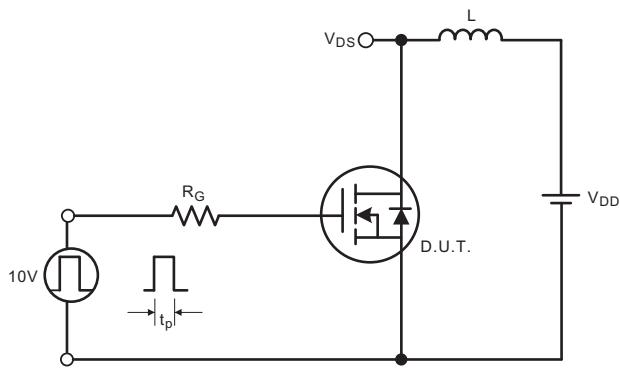
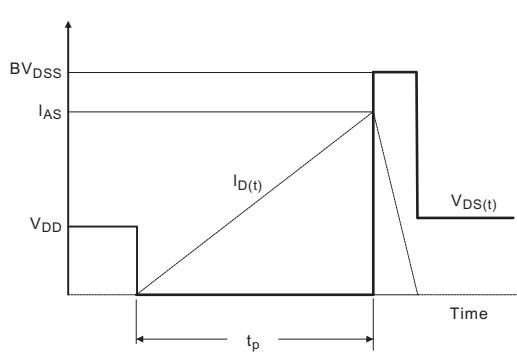


Fig.1B Peak diode recovery dv/dt waveforms



■ TEST CIRCUITS AND WAVEFORMS(Cont.)
Fig.2A Switching test circuit

Fig.2B Switching Waveforms

Fig.3A Gate charge test circuit

Fig.3B Gate charge waveform

Fig.4A Unclamped Inductive switching test circuit

Fig.4B Unclamped Inductive switching waveforms


■ TYPICAL CHARACTERISTICS

Fig.1 On-State characteristics

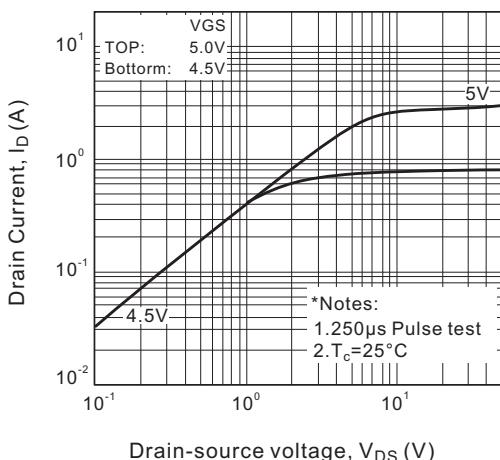


Fig.2 Transfer characteristics

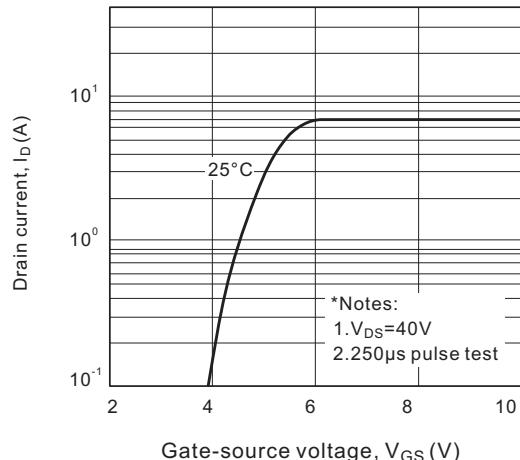


Fig.3 On-resistance variation vs. drain current and gate voltage

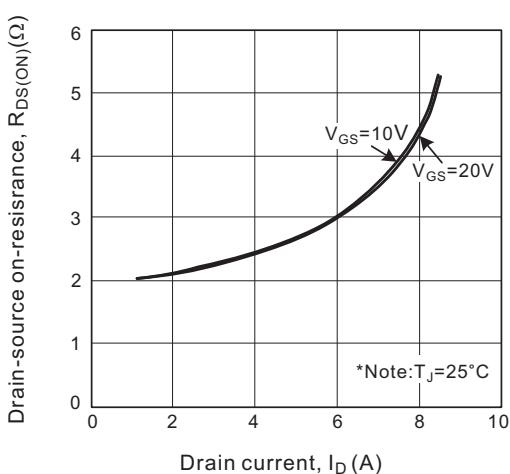
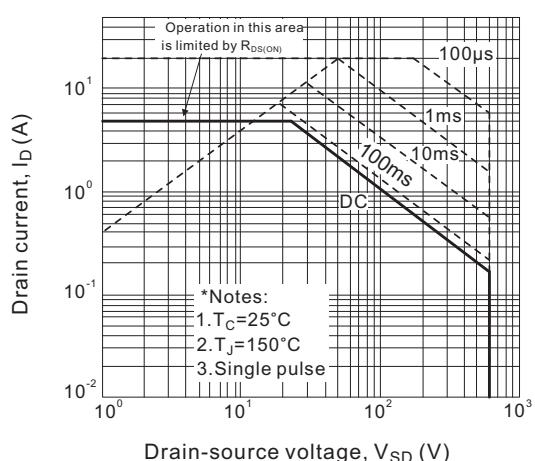
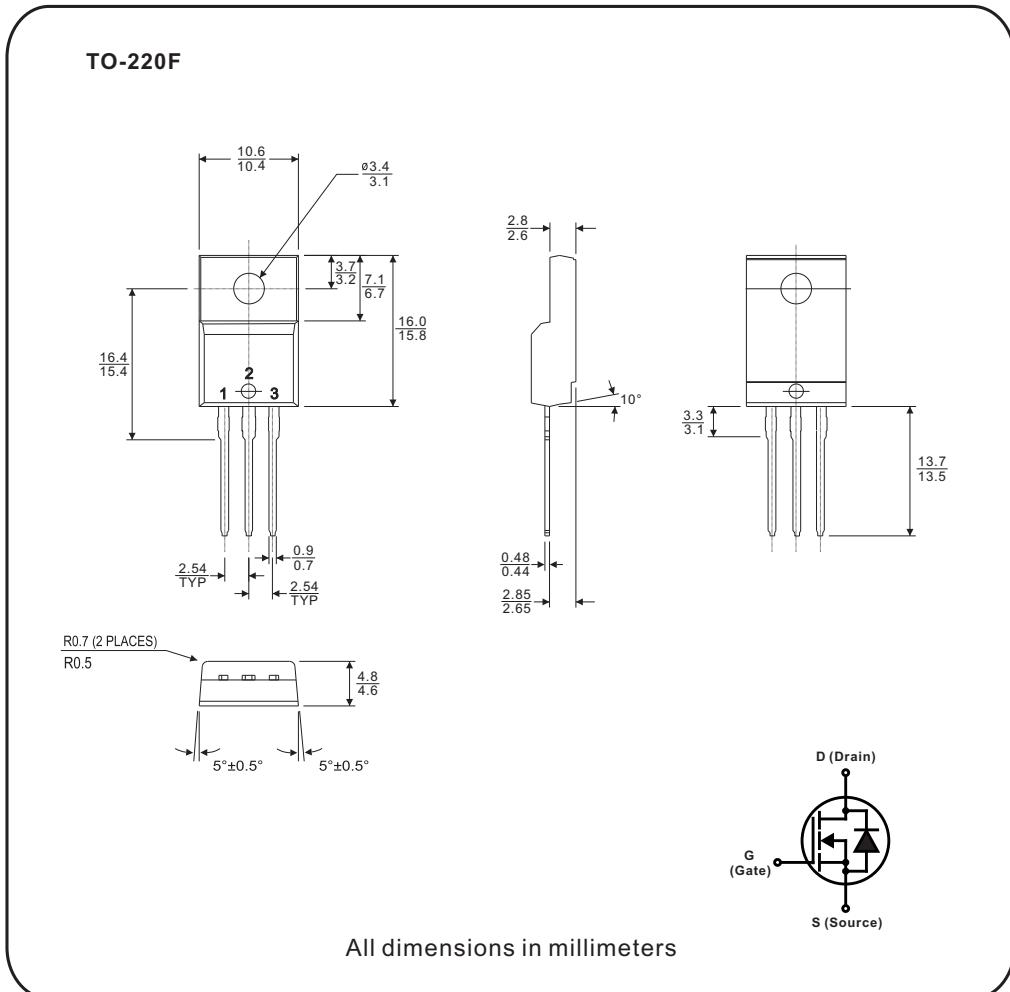
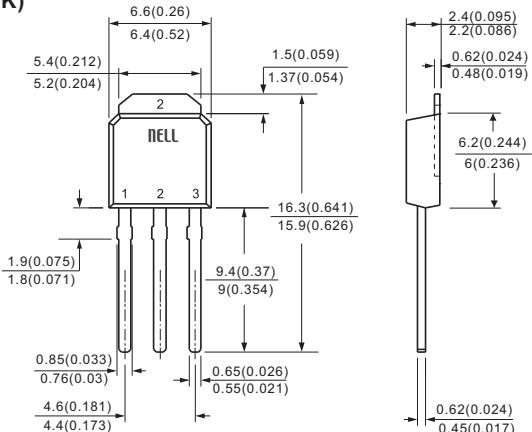
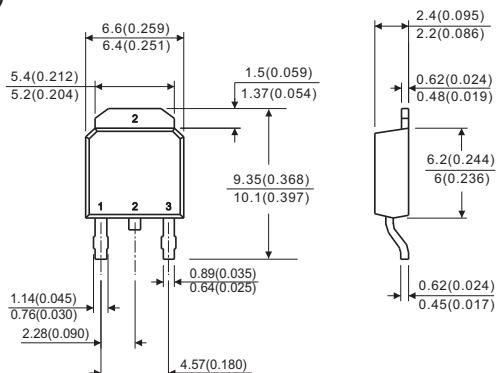
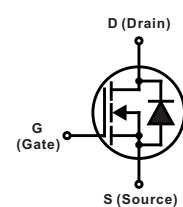
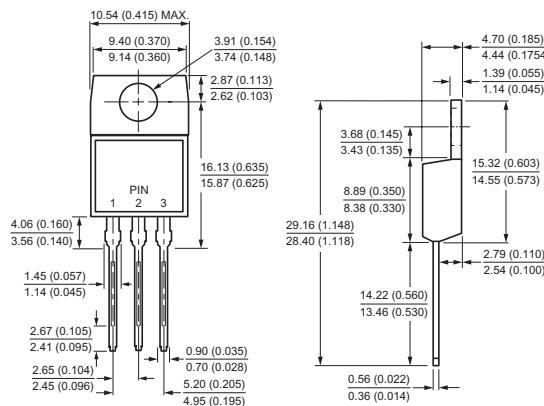


Fig.4 Maximum safe operating area



Case Style



Case Style
Nell High Power Products
**TO-251
(I-PAK)**

**TO-252
(D-PAK)**

TO-220AB


All dimensions in millimeters(inches)